

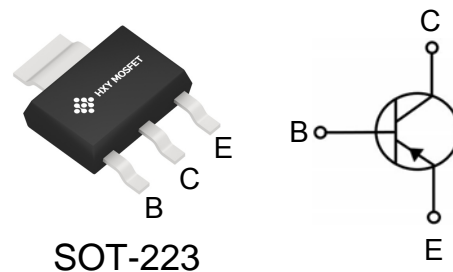


## Features

- Collector Current:  $I_C=1A$
- Power Dissipation of 1.5W

## Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
BSP41	SOT-223	BCP55	1000



## Maximum Ratings ( $T_a=25^{\circ}C$ unless otherwise noted)

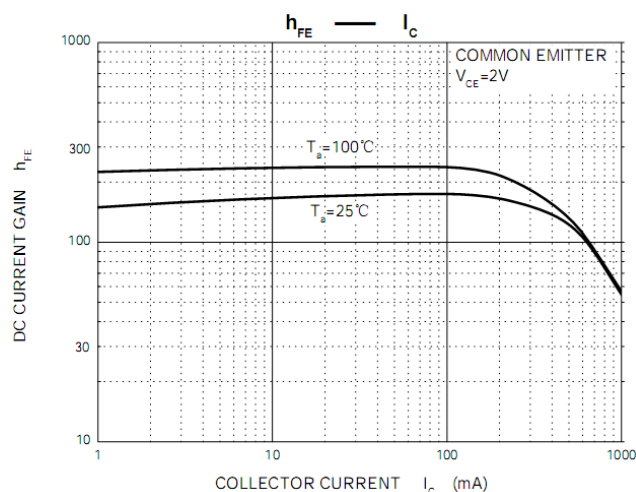
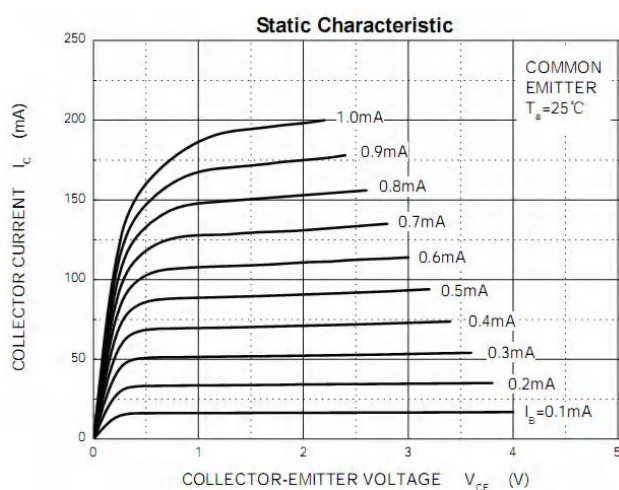
Parameter	Symbol	Limit	Unit
Collector-Base Voltage	$V_{CBO}$	60	V
Collector-Emitter Voltage	$V_{CEO}$	60	V
Emitter-Base Voltage	$V_{EBO}$	5	V
Collector Current	$I_C$	1	A
Collector Power Dissipation	$P_C$	1.5	W
Thermal Resistance From Junction To Ambient	$R_{\theta JA}$	83.3	$^{\circ}C/W$
Junction Temperature	$T_J$	150	$^{\circ}C$
Storage Temperature	$T_{stg}$	-55~+150	$^{\circ}C$

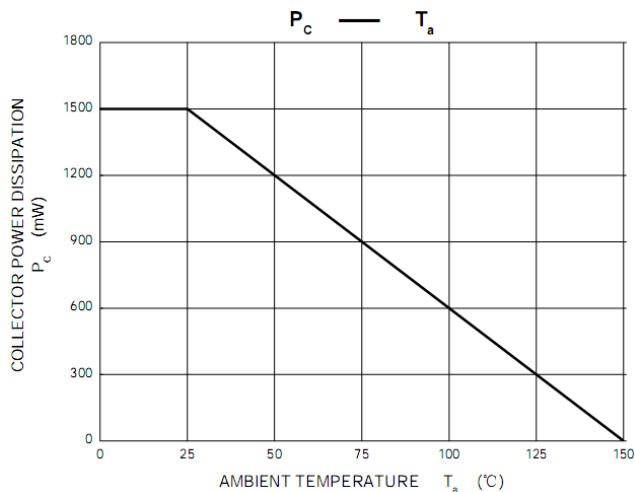
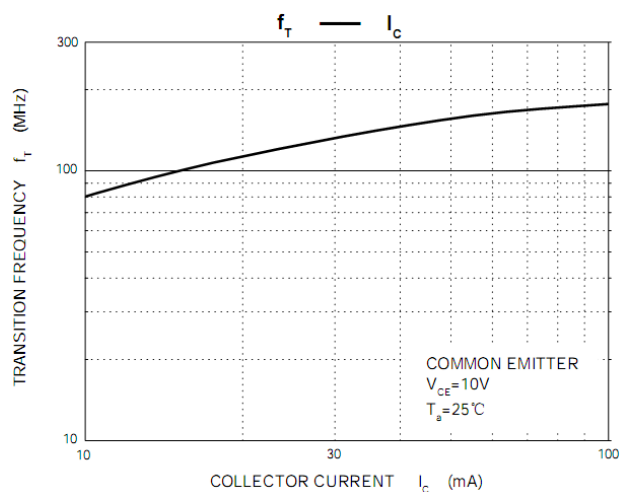
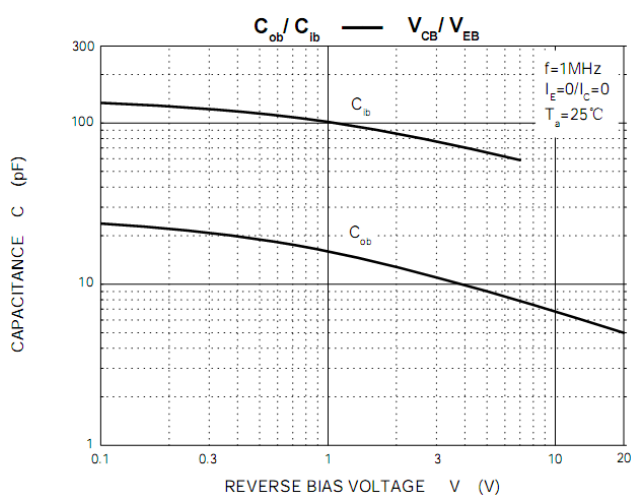
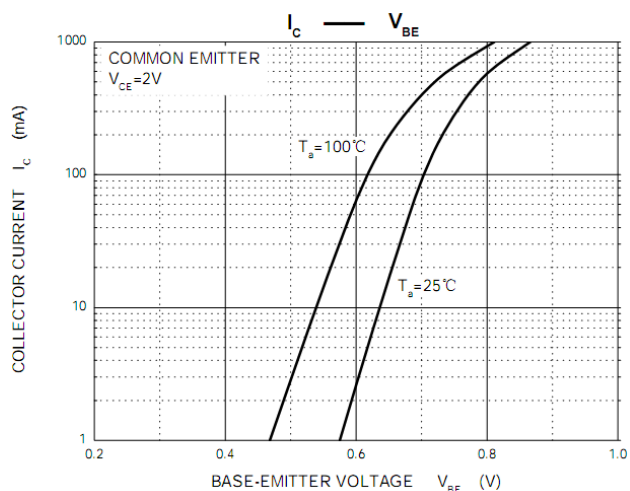
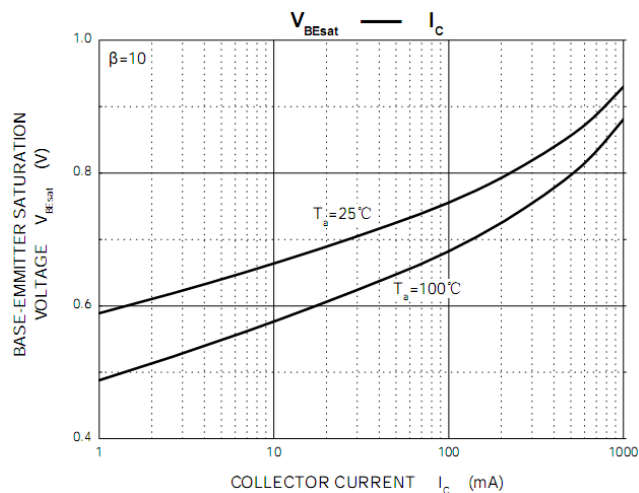
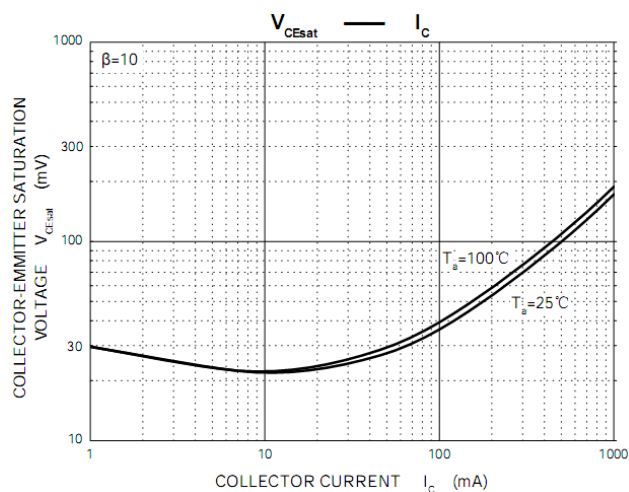


### Electrical Characteristics (Ta=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C = 0.1mA, I_E = 0$	60		V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C = 10mA, I_B = 0$	60		V
Base-emitter breakdown voltage	$V_{(BR)EBO}$	$I_E = 10\mu A, I_C = 0$	5		V
Collector cut-off current	$I_{CBO}$	$V_{CB} = 30V, I_E = 0$		100	nA
DC current gain	$h_{FE(1)}$	$V_{CE} = 2V, I_C = 5mA$	25		
	$h_{FE(2)}$	$V_{CE} = 2V, I_C = 150mA$	100	250	
	$h_{FE(3)}$	$V_{CE} = 2V, I_C = 500mA$	25		
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 500mA, I_B = 50mA$		0.5	V
Base-emitter voltage	$V_{BE}$	$V_{CE} = 2V, I_C = 500mA$		1	V
Transition frequency	$f_T$	$V_{CE} = 10V, I_C = 50mA, f = 100MHz$	100		MHz

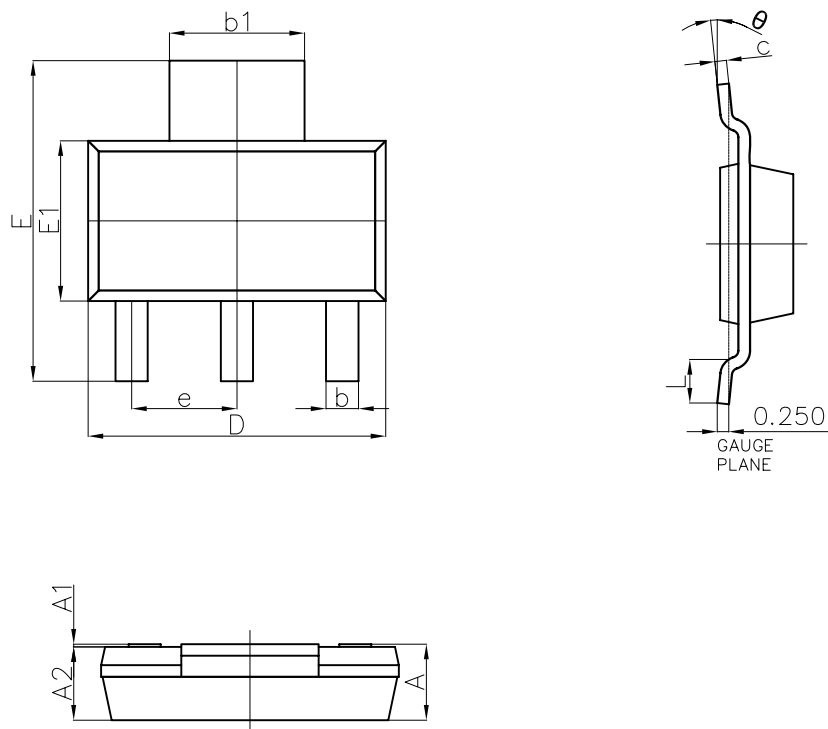
### Typical Characteristics







## SOT-223 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	—	1.800	—	0.071
A1	0.020	0.100	0.001	0.004
A2	1.500	1.700	0.059	0.067
b	0.660	0.840	0.026	0.033
b1	2.900	3.100	0.114	0.122
c	0.230	0.350	0.009	0.014
D	6.300	6.700	0.248	0.264
E	6.700	7.300	0.264	0.287
E1	3.300	3.700	0.130	0.146
e	2.300(BSC)		0.091(BSC)	
L	0.750	—	0.030	—
θ	0°	10°	0°	10°



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